

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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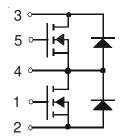




Advance Technical Information

Trench Gate HiperFET N-Channel Power MOSFET

FMM60-02TF



Phase Leg Topology

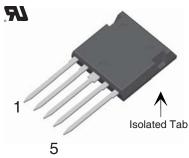
Symbol	Test Conditions	Maximum Ratings		
T,		-55 +150	°C	
T _{JM}		150	°C	
T _{stg}		-55 +150	°C	
V _{ISOLD}	50/60H _z , RMS, t = 1min, leads-to-tab	2500	~V	
T,	1.6mm (0.062 in.) from case for 10s	300	°C	
T _{SOLD}	Plastic body for 10s	260	°C	
F _c	Mounting force	20120 / 4.527	N/lb.	
	Plastic body for 10s	260	-	

Symbol	Test Conditions	Maximum Ratings	Maximum Ratings		
V _{DSS}	$T_J = 25^{\circ}C \text{ to } 150^{\circ}C$	200	V		
\mathbf{V}_{DGR}	$T_J = 25^{\circ}C$ to 150°C, $R_{GS} = 1M\Omega$	200	V		
V _{GSM}	Transient	± 30	V		
I _{D25}	T _C = 25°C	33	Α		
I _{DM}	$T_{\rm C} = 25^{\circ}$ C, pulse width limited by $T_{\rm JM}$	150	Α		
I _A	$T_c = 25^{\circ}C$	5	Α		
E _{AS}	$T_{c} = 25^{\circ}C$	1	J		
dV/dt	$I_{_{S}} \le I_{_{DM}}, V_{_{DD}} \le V_{_{DSS}}, T_{_{J}} \le 150^{\circ}C$	10	V/ns		
P _D	T _c = 25°C	125	W		

Symbol	Test Conditions	Chara Min.	acteristic Values Typ. Max.		
C _P	Coupling capacitance between shorted pins and mounting tab in the case		40	pF	
d_s, d_A d_s, d_A	pin - pin pin - backside metal	1.7 5.5		mm mm	
Weight			9	g	

 $V_{DSS} = 200V$ $I_{D25} = 33A$ $R_{DS(on)} \le 40m\Omega$ $t_{rr(typ)} = 82ns$

ISOPLUS i4-Pak™



Features

- Silicon chip on Direct-Copper Bond (DCB) substrate
 - UL recognized package
 - Isolated mounting surface
 - 2500V electrical isolation
- Avalanche rated
- Low Q_G
- Low Drain-to-Tab capacitance
- Low package inductance

Advantages

- Low gate drive requirement
- High power density
- Fast intrinsic rectifier
- Low drain to ground capacitance
- Fast switching

Applications

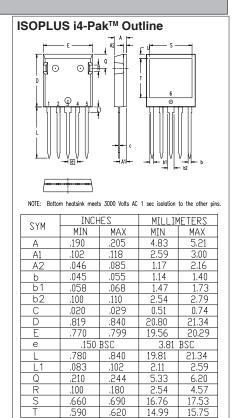
- DC and AC motor drives
- UPS, solar and wind power inverters
- Synchronous rectifiers
- Multi-phase DC to DC converters
- Industrial battery chargers
- Switching power supplies





FMM60-02TF

Symbol (T _J = 25°C u	Test Conditions ² nless otherwise specified)	Characteristic Values Min. Typ. Max.		
BV _{DSS}	$V_{GS} = 0V, I_{D} = 250\mu A$	200		V
V _{GS(th)}	$V_{DS} = V_{GS}$, $I_{D} = 250\mu A$	2.5		4.5 V
I _{GSS}	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			± 200 nA
I _{DSS}	$V_{DS} = V_{DSS}$ $V_{GS} = 0V$ $T_{J} = 125^{\circ}C$			5 μA 250 μA
R _{DS(on)}	$V_{GS} = 10V, I_{D} = 30A, Note 1$		32	40 mΩ
g _{fs}	$V_{DS} = 10V, I_{D} = 60A, Note 1$	40	62	S
C _{iss}			3700	pF
C _{oss}	$V_{GS} = 0V, V_{DS} = 25 V, f = 1 MHz$		520	pF
C _{rss}			37	pF
t _{d(on)}	Resistive Switching Times		39	ns
t, \	$V_{GS} = 10V$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_{D} = 30A$		46	ns
t _{d(off)}	$R_{\rm G} = 5\Omega$ (External)		75	ns
t _f			42	ns
$Q_{g(on)}$			90	nC
Q _{gs}	$V_{GS} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 30A$		33	nC
Q_{gd}			21	nC
\mathbf{R}_{thJC}				1.0 °C/W
R _{thCS}			0.15	°C/W



.065

.080

1.65

2.03 Ref: IXYS CO 0077 R0

Source-Drain Diode

Cumbb al

Characteristic Values

T₁ = 25°C unless otherwise specified)

Symbol	Test Conditions	Min.	Typ.	мах.	
Is	$V_{GS} = 0V$			33	Α
I _{SM}	Repetitive, pulse width limited by $T_{_{\rm JM}}$			150	Α
V _{SD}	$I_F = 60A, V_{GS} = 0V, Note 1$			1.5	V
t _{rr}	$I_F = 25A$, $-di/dt = 100A/\mu s$		82 15.3		ns A
Q_{RM}	$V_{R} = 100V, V_{GS} = 0V$		0.63		μС

Note 1: Pulse test, $t \le 300\mu s$, duty cycle, $d \le 2 \%$.

Took Conditions

ADVANCE TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from a subjective evaluation of the design, based upon prior knowledge and experience, and constitute a "considered reflection" of the anticipated objective result. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

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